

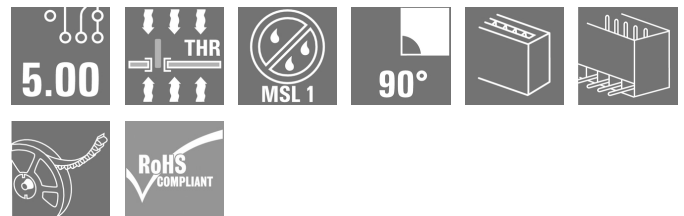
SL-SMT 5.00HC/06/90G 3.2AU BK RL**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 5.00 mm, Number of poles: 6, 90°, Solder pin length (l): 3.2 mm, Gold-plated, black, Tape
Order No.	1161680000
Type	SL-SMT 5.00HC/06/90G 3.2AU BK RL
GTIN (EAN)	4032248950652
Qty.	350 pc(s).
Product data	IEC: 400 V / 27.5 A UL: / 18.5 A
Packaging	Tape

Creation date July 13, 2025 10:30:46 AM CEST

Catalogue status 04.07.2025 / We reserve the right to make technical changes.

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Technical data**Dimensions and weights**

Depth	12 mm	Depth (inches)	0.472 inch
Height	18.74 mm	Height (inches)	0.738 inch
Height of lowest version	8.5 mm	Width	33.2 mm
Width (inches)	1.307 inch	Net weight	3.87 g

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.00	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 "	Outgoing elbow	90°
Number of poles	6	Solder pin length (l)	3.2 mm
Solder pin length tolerance	+0.1 / -0.2 mm	Solder pin dimensions	d = 1.2 mm, Octagonal
Solder pin dimensions = d tolerance	0 / -0.03 mm	L1 in mm	25 mm
L1 in inches	0.984 "	Number of rows	1
Pin series quantity	2	Touch-safe protection acc. to DIN VDE 57 106	finger-safe unplugged/ back-of-hand-safe plugged
Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged	Protection degree	IP20
Volume resistance	≤5 mΩ	Plugging force/pole, max.	7 N
Pulling force/pole, max.	5.5 N		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIla
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	Gold-plated	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn / 1.7...2.3 µm Au	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated impulse voltage for surge voltage class/ pollution degree II/2	4,000 V
Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV		

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Technical data

Rated data acc. to CSA

Institute (CSA)



Certificate No. (CSA)

200039-1176845

Rated current (Use group B / CSA)

15 A

Rated current (Use group D / CSA)

15 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Rated data acc. to UL 1059

Institute (UR)



Certificate No. (UR)

E60693

Rated current (Use group B / UL 1059)

18.5 A

Reference to approval values

Specifications are maximum values, details - see approval certificate.

Packing

ESD Level packaging static dissipative

VPE length 332 mm

VPE height 64 mm

Tape width (W) 44 mm

Tape pocket height (A0) 12.3 mm

Tape pocket separation (P1) 16 mm

Tape pocket separation (F) 20.2 mm

Surface resistance $R_s = 10^9 - 10^{12} \Omega$

Packaging Tape

VPE width 332 mm

Tape depth (T2) 12.8 mm

Tape pocket depth (K0) 12.3 mm

Tape pocket width (B0) 33.98 mm

Tape hole separation (E) 1.75 mm

Tape reel diameter $\varnothing$ (A) 330 mm

Classifications

ETIM 6.0 EC002637

ETIM 8.0 EC002637

ETIM 10.0 EC002637

ECLASS 9.1 27-44-04-02

ECLASS 11.0 27-46-02-01

ECLASS 13.0 27-46-02-01

ECLASS 15.0 27-46-02-01

ETIM 7.0 EC002637

ETIM 9.0 EC002637

ECLASS 9.0 27-44-04-02

ECLASS 10.0 27-44-04-02

ECLASS 12.0 27-46-02-01

ECLASS 14.0 27-46-02-01

Approvals

Approvals



Approvals MAMID

https://mdcop.weidmueller.com/mediadelivery/rendition/900_319226/-T1z1mm-S800/ https://mdcop.weidmueller.com/mediadelivery/rendition/900_319262/-T1z1mm-S800/

ROHS Conform

UL File Number Search UL Website

Certificate No. (UR) E60693

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www.weidmueller.com**Technical data****Environmental Product Compliance**

RoHS Compliance Status	Compliant without exemption
REACH SVHC	No SVHC above 0.1 wt%

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Downloads

Product Change Notification	PCN_2015_208_PL30X_SC-SMT_SL_SMT_3.xx_5.xx_neue_Tapeverpackung_Step_4_DE PCN_2015_208_PL30X_SC-SMT_SL_SMT_3.xx_5.xx_new_Tape_Packaging_Step_4_EN Changeover to ESD bags for "Tape on Reel" products Umstellung auf ESD-Beutel bei „Tape on Reel“ Produkten
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN FL DRIVES DE
White paper surface mount technology	Download Whitepaper

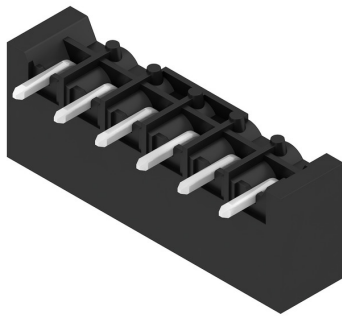
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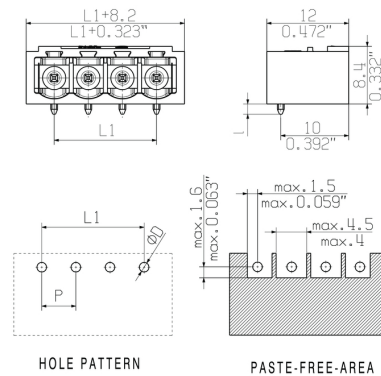
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Drawings

Product image



Dimensional drawing



Product benefits



Safe power transmission
Proven properties

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Drawings

Product benefits



Compliant with existing standards

Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.